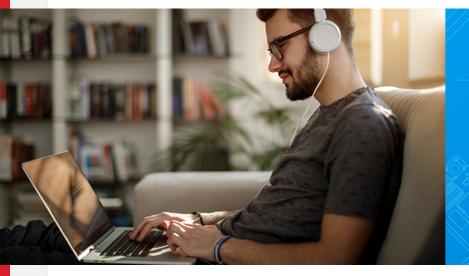


WELCOME



Silicon Labs LIVE: Wireless Connectivity Tech Talks

Talk Talks LIVE Schedule

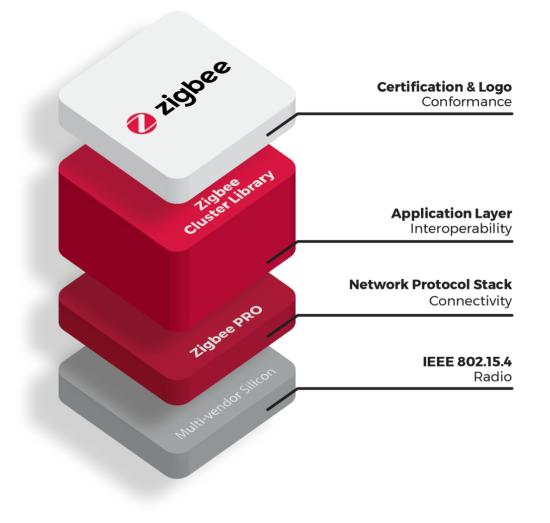
Торіс	Date
Bluetooth AoX Solutions	Thursday, April 2
15.4 Mesh Networking Technologies	Tuesday, April 7
Bluetooth Mesh Solutions & Tools	Thursday, April 9
Device & Network Security for the IoT	Tuesday, April 14
Evolution of Bluetooth 5, 5.1, & 5.2	Thursday, April 16
Connected Home Over IP (CHIP) for Beginners	Tuesday, April 21



802.15.4 Mesh Networking Overview

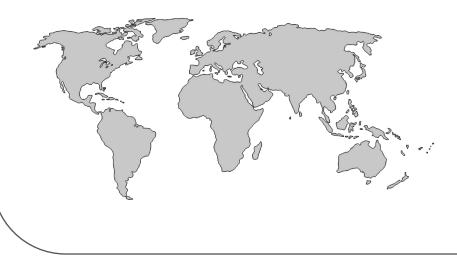
Zigbee and Thread

APRIL 2020



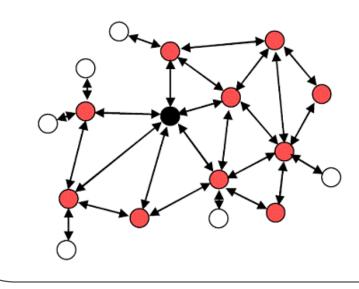


- Standards-based
- Low power
- Low data rate (250 kbps) for monitoring & control
- 2.4 GHz global ISM band





- Intelligent Mesh Routing
 - Reliable and robust
 - Lower power vs. star topology
 - Efficient use of spectrum
 - Scalable for large networks

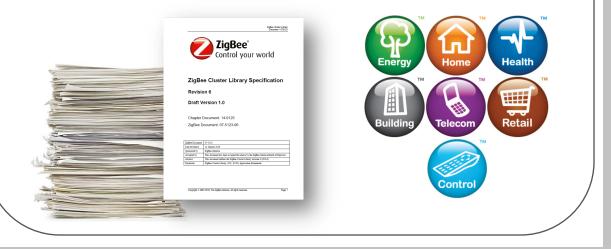




- Zigbee Cluster Library
 - 15 years of development and learning
 - 400+ companies (competing mfg.)
 - 1,000 page specification

100+ clusters and device types Cluster = functional building blocks (e.g. level control)

Cluster = functional building blocks (e.g. level control) Device types = shade controller, on/off/dim light, t-stat

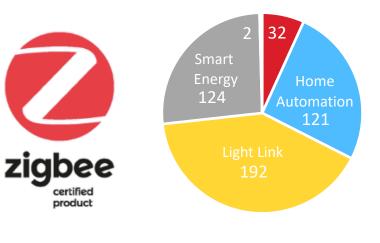




 Certification includes stack and application layer for interoperability

Zigbee Certifications (2017)

■ 3.0 ■ HA ■ ZLL ■ SE ■ GP



Silicon Labs Zigbee Leadership

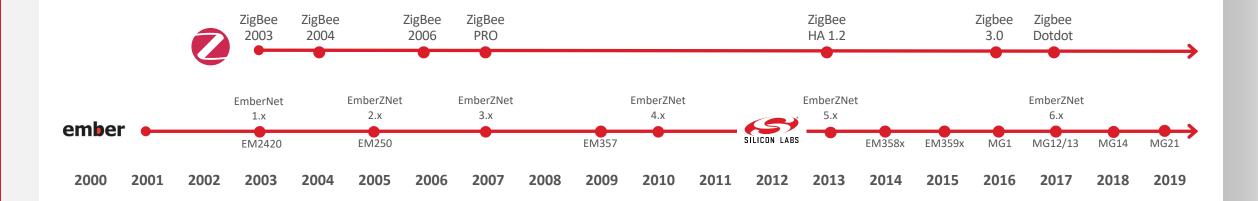
Pioneers in Mesh Networking

Leadership, Deep Experience, Strong Continued Investment

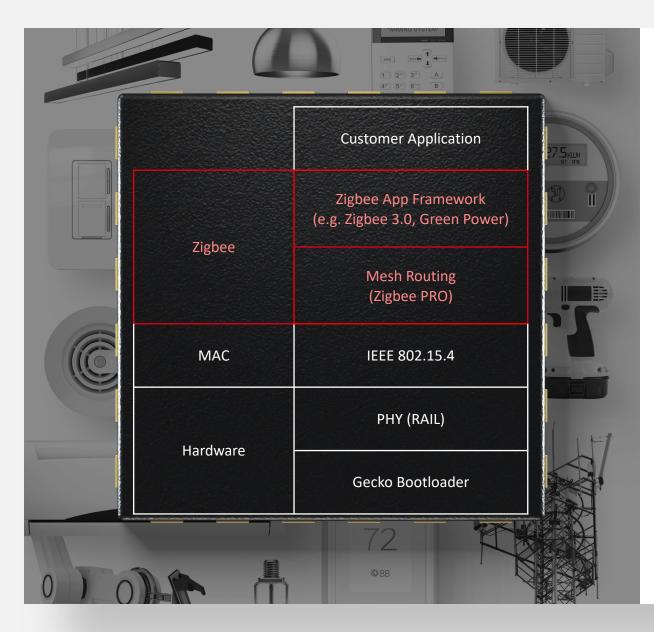
💋 zigbee

Board of Directors Technical Committee Chair Testing & Certification Chair Core Stack WG Chair Mesh IP WG Chair

Key Technical Contributor



Zigbee Software



Fully Integrated Stack Architecture

- Zigbee 3.0 certified platform
- Application Framework
 - Zigbee 3.0 / Green Power/ Smart Energy
- Support for SoC and NCP architectures

Flexible, easy-to-use

- Commissioning and security
- Seamless integration with AppBuilder
- EZSP serial protocol for NCP over UART or SPI

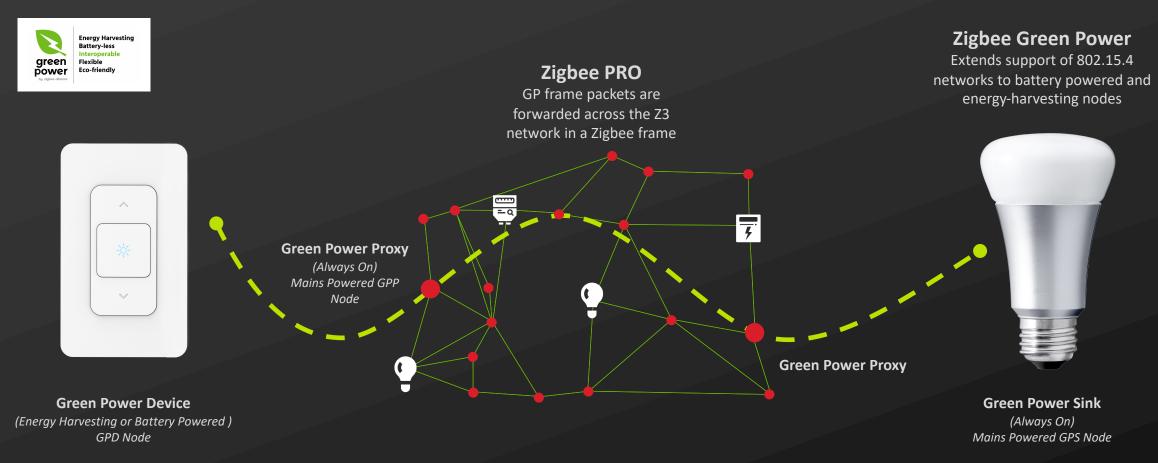
Field Upgradable

- Over-the-Air firmware updates
- NCP firmware updates over serial interface

Zigbee PRO & Zigbee Green Power

Zigbee Green Power uses the same lower layers, with compressed messages (20% of Zigbee PRO energy)

Low power mesh technology built on 802.15.4 MAC/PHY



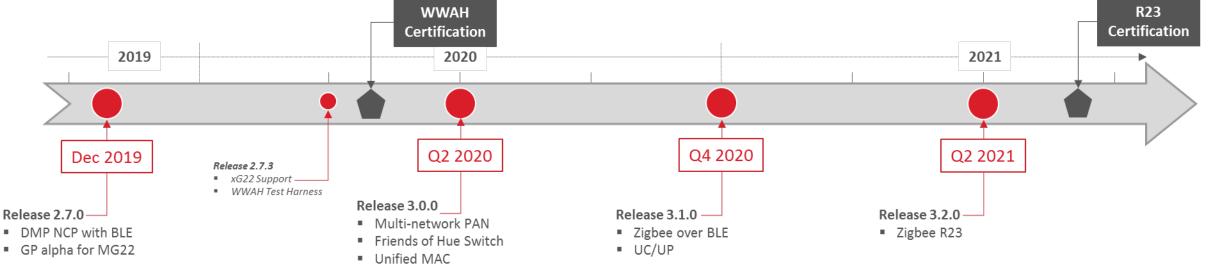
Zigbee 3.0 (EmberZNet) SDK

- Dynamic Multiprotocol Zigbee and Bluetooth
 - Develop devices that work simultaneously over BLE and Zigbee
 - Fully integrated GATT configurator
- Zigbee Green Power (GPD, Sink, GPPB)
 - Proxy functionality required for Zigbee 3.0
 - Expand energy savings of Zigbee Pro by 5x
- Works With All Hubs
 - Easily integrate into Amazon ecosystem
 - Test harness provided by Silicon Labs running on EFR32

- Friends of Hue
 - Easily integrate into Philips Hue ecosystem
 - Sample applications for battery powered switches
- Low Power Support
 - EM2 to support long-lasting battery powered sensors
- Wi-Fi Coexistence
 - Managed coexistence with PTA interface
 - Un-managed coexistence with great blocking performance

Upcoming Zigbee R23

- Improved security and commissioning
- Routing improvements



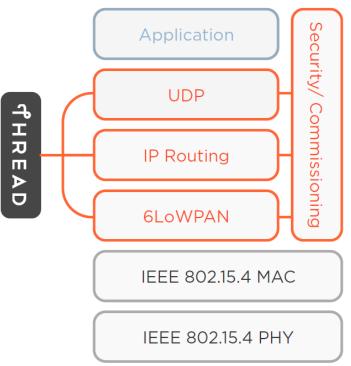


Thread Overview



- IPv6-based, low-power, secure mesh networking protocol
- Built for the IoT smart home, commercial buildings
- Intended for control and automation (250 kbps)
- Scalable to 250+ nodes per subnet
- Runs on existing 802.15.4 wireless SoCs

Thread can support many popular application layer protocols



OpenThread Overview

OPENTHREAD released by Google

- OpenThread is an open-source implementation of the Thread networking protocol
- Thread 1.1 certification on EFR32 running OpenThread
- OpenThread GitHub example drivers
 - EFR32MG12
 - EFR32MG13
 - EFR32MG21
- Support for OpenThread Border Router
 - Raspberry Pi host
 - EFR32 NCP





Company:

Model:

Thread Interoperability Certificate This certificate lists the features that have passed Thread specification compliance and interoperability testing. See http://threadgroup.org/technology/ourtechnology for more details



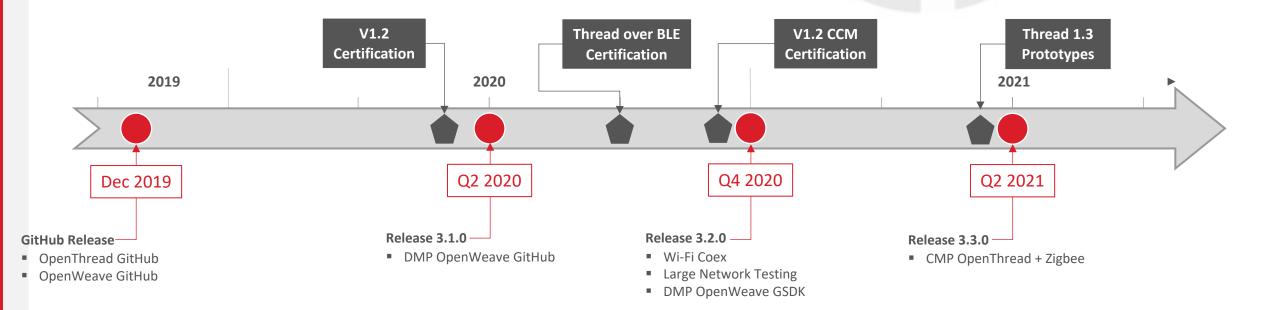
OpenThread SDK

- Dynamic Multi-Protocol Thread and Bluetooth
 - Develop devices that work simultaneously over BLE and Thread
- OpenWeave Door Lock Sample App
 - Control via Thread and BLE
 - Easily integrate into Google ecosystem
- NCP Support
 - Develop a border router application using a Raspberry Pi
 - Works with the Thread commissioning app

- Development Tools
 - Network Analyzer
 - Large Network Testing
- Certification
 - Thread 1.1 certification on EFR32 running OpenThread

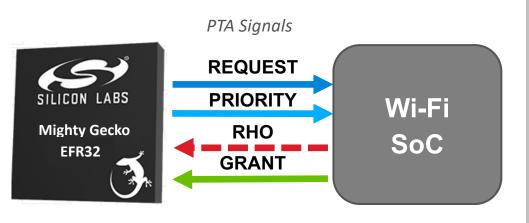
OPENTHREA

- Wi-Fi Coexistence (Roadmap)
 - Managed coexistence with PTA interface
 - Un-managed coexistence with great blocking performance



Managed Wi-Fi Co-Existence

- Managed co-existence solutions for Zigbee/Thread/Bluetooth and Wi-Fi
- Based on IEEE 802.15.2 Packet Traffic Arbitration (PTA)
- Supports Network Co-Processor (NCP) architecture for gateway applications
- Flexible interface
 - 1- to 4-wire implementations
 - Configurable pin selections, active high/low, timing, etc.
- Performance tested with leading Wi-Fi chipsets
- See <u>AN1017</u> app note for more details



Network Analyzer

- Network Analyzer - Live cap	ure streamStack version: Connect stack, Default profile - Simplicity Studio ™	- 🗆 X				
File Edit Filters Window He	lp					
	" \$* ! ৵ \$\$!\$* @ ! !! + ?! + ?> + ! @ \$?? * ! % 4 % <mark>∅ ,,,</mark> & @ K & & E	+∃ +\$ +\$ ▼ T 🥖 坐 🕨 🔛 🐏				
😰 🏫 Launcher 🚯 Simplicity	IDE 🎋 Debug 🤳 Network Analyzer					
• Devices: 2 ×						
S 😂 🖉 X X 🔅 ▼ 🗖 🛱	▲ *Live [™]					
> 🛃 J-Link Silicon Labs (4400)	0 saved filters AND	✓ \$\\$ © @ \$\\$				
> 🧏 J-Link Silicon Labs (4400)	2.00 p/s	1.278s				
	0.001s	1.280s				
	Time:1.278362s Real time:N/A Nodes:1 Event:EFR Tx packet	Event Detail				
		> IEEE 802.15.4 [10 bytes] ^				
	A set in	 Connect Network Frame [5 bytes] 				
		Frame control: 0x00				
	0004 (00804.57	Frame type: Data frame (0) Endpoint ID: 0x00				
	0680	Destination address: 0xFFFF				

	Transactions total:1 shown:1					
	Time Dur Summary NWK Src NWK D P# M# E# Status	Protocol Id: Sensor/Sink (0xC00F)				
	I 1.278362 0.001 Sensor/Sink: Advertise 0000 FFFF 1 Missing p	Sensor Sink Command Id: Advertise (0x01)				
		Hex Dump [35 bytes] 🗢 🗖				
		FC 1D 41 88 4C FF 01 FFA.L				
	Events total:3 shown:3 Decoders: Connect stack, Default profile	□ 0F C0 01 72 5F 16 FE FFr 57 0B 00 00 00 50 B5 FD WP				
	Time Type Summary MAC MAC Status	01 00 00				
	0.0007 Packet Beacon Request FFFF					
	0.0056 Packet Beacon 0000					
	L 1.2783 Packet Sensor/Sink: Advertise 0000 FFFF					
	# J-Link Silicon Labs (440080496) ☆					
	No translation V Line terr No translation	 Line terminator: CR-LF (DOS, OS/2, MS 				
	Serial 0 Z Serial 1 Z Admin Z Debug	-				
	<pre></pre>	<uint8_t> -</uint8_t>				
	advertise - form 0x00 counter (uint8 t) - sink/TX: Advertise to 0xFFFF	7. 0w00				
	counter (uint8_t) - sink>TX: Advertise to 0xFFF					

- Network-wide view of all packet activity
 - Correlates network traffic into events
 - Custom decoding and filtering options
 - Log files accelerate Silicon Labs support
- Uses unique Packet Trace Port feature
 - 2-wire interface
 - Outputs every packet TX/RX with link quality
 - Can be used to output application debug statements



Advanced system-wide network debug and support

A Common Platform

	🛞 Bluetooth [°]			💋 zigbee	FLEX SDK	
	Customer	Application	Customer Application	Customer Application		
Application GATT Mesh Models (profiles / services) (e.g. lighting)			Application Layer (e.g. Project CHIP, OpenWeave, CoAP)	Customer Applicat Application Profile (e.g. Zigbee 3.0, ZLL, SE)		Application
			UDP			
,	Bluetooth LE Core	Bluetooth Mesh Core	IPv6, Mesh Routing	Zigbee Core Stack	Connect Stack	Customer Proprietary Stack
nanopore			6LoWPAN			
Link	Bluetooth Link Layer		IEEE 802.15.4 MAC	IEEE 802.15.4 MAC	IEEE 802.15.4 like MAC	SLACK
Physical	Bluetooth PHY (2.4 GHz)		IEEE 802.15.4 PHY (2.4 GHz)	IEEE 802.15.4 PHY (2.4 GHz)		tary PHY or Sub-GHz)
RAIL		RAIL	RAIL	R	AIL	
Platform	Platform Common Bootloader		Common Bootloader	Common Bootloader	Common Bootloader	

Multiprotocol Options

Туре	Definition
Programmable	Device programmed with either Zigbee or OpenThread in manufacturing
Switched	Application switches between Zigbee and OpenThread via bootloader
Dynamic	Application runs simultaneously (time-sliced) Zigbee and BLE or OpenThread and BLE
Concurrent	Application runs both Zigbee and OpenThread in a single radio (on same RF channel)

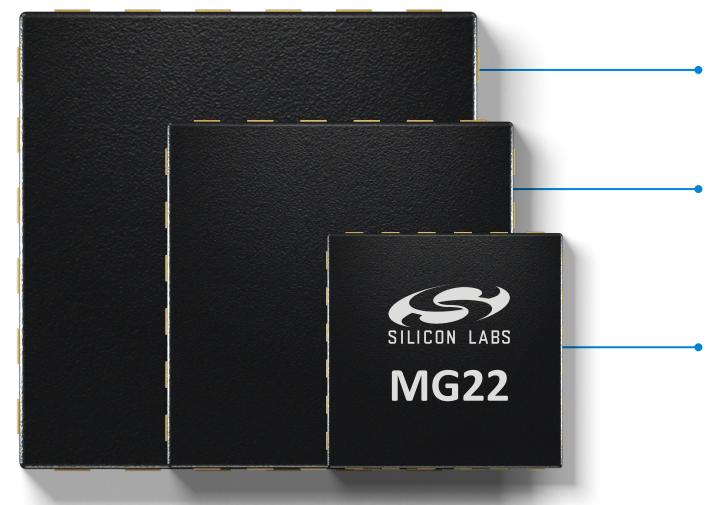
Mesh SoC Portfolio Highlights



	Series 1 – MG12	Series 2 – MG21	Series 2 – MG22	
Target applications	Mesh Routers and End Devices	Mesh Routers and End Devices	Zigbee End Devices only	
Availability	Now	Now	Now	
Zigbee features	Zigbee 3.0, Green Power, Concurrent Zigbee/Thread Multiprotocol (Zigbee/BLE)	Zigbee 3.0, Green Power, Concurrent Zigbee/Thread, Multiprotocol (Zigbee/BLE)	Zigbee 3.0 (SoC only), Green Power Green Power Device	
Proprietary 2.4G	2/4(G)FSK, OQPSK/(G)MSK, DSSS, BPSK/DBPSK TX, OOK/ASK	N/A	2/4(G)FSK, (G)MSK, OQPSK, DSSS	
TX / RX (802.15.4)	+19 dBm / -102.7 dBm	+20 dBm / -104.5 dBm	+6 dBm / -102.3 dBm	
TX Current	9.5 mA (@ 0 dBm)	9.3 mA (@ 0 dBm)	4.1 mA (@ 0 dBm), 8.2 mA (@+6 dBm)	
RX Current (802.15.4)	11.9 mA	9.4 mA	3.9 mA	
CPU / Clock Speed	Cortex M4 (38.4 MHz)	Cortex M33 (80Mhz)	Cortex M33 (76.8MHz), Cortex M0+ for radio	
Flash (kB)	1024	Up to 1024	Up to 512	
RAM (kB)	256	Up to 96	32	
Sleep Current (EM2)	1.5μΑ (16kB RAM)	4.5 μA (96 RAM)	1.4 μA (32kB RAM)	
Active Current (EMO)	70 μA/MHz	51 µA/MHz	26 μA/MHz	
Security	2x AES-128/256, ECC, SHA-1/224/256, TRNG	AES-128/256, SHA-1/2, ECC, ECDSA and TRNG DPA countermeasures Secure boot with RTSL Secure OTA and secure debug unlock + Secure Enclave (BG21B)	AES-128/256, SHA-1/2 ECC, ECDSA and TRNG Secure boot with RTLS Secure OTA and secure debug unlock	
Operating Voltage	1.8V-3.6V	1.71V-3.8V	1.71V - 3.8V	
Packages (mm)	7x7 QFN48	4x4 QFN32 (20x GPIO)	5x5 QFN40 (26x GPIO) 4x4 QFN32 / TQFN32 (18x GPIO)	

Choosing an MG Device

Increasing Features



MG12 / MG21

Highest integration Large memory for dual-protocol and OTA Variants with highest security

MG13

Balance of features, size, power, cost Supports dual-protocol

The new MG22

Focused on simple low cost Zigbee node applications

- Optimized for simple end nodes
- Lowest power
- Lowest cost
- New Security Features

Mesh Module Portfolio

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SILICON LABS







	MGM12P	MGM13P	MGM13S	MGM210P	MGM210L	
Protocols	Bluetooth 5.0 & mesh Zigbee or Thread	Bluetooth 5.1 & mesh Zigbee or Thread	Bluetooth 5.1 & mesh Zigbee or Thread	Bluetooth 5.1 & mesh Zigbee or Thread	Bluetooth 5.1 & mesh Zigbee or Thread	
Status	Production	Production	Production	Production	Production	
EFR32 SoC	xG12	xG13	xG13	xG21	xG21	
Antenna	Chip or U.FL	Chip or U.FL	Chip or RF pin	Chip or RF pin	PCB trace antenna	
Max TX power	+8 / +19 dBm	+8 / +19 dBm	+8 / +18 dBm	+10 / +20 dBm	+12.5 dBm	
(250 kbps O-QPSK)	-95 dBm	-95 dBm	-94 dBm	-104.5 dBm	-104.5 dBm	
TX (125 kbps GFSK)	N/A	-103.2 dBm	-102.1 dBm	-105 dBm	-105 dBm	
(1Mbps GFSK)	-95 dBm	-95 dBm	-94 dBm	-97 dBm	-97 dBm	
Flash / RAM	512 / 64 kB	512 / 64 kB	512 / 64 kB	1024 / 96 kB	1024 / 96 kB	
GPIO	25	25	30	20	12	
Operating Voltage	1.8 to 3.6 V	1.8 to 3.6 V	1.8 to 3.6 V	1.71 to 3.8 V	1.8 to 3.8 V	
Operating Temperature	-40°C to +85°C	-40°C to +85°C	-40°C to +85°C	-40°C to +125°C	-40°C to +125°C	
Dimensions W x L x H (mm)	12.9 x 15 x 2.2	12.9 x 15 x 2.2	6.5 x 6.5 x 1.4	12.9 x 15 x 2.2	15.5 x 22.5 x 2.3	
Certifications	BT, CE, FCC, ISED, Japan, S-Korea and Taiwan Japa		BT, CE, FCC, ISED, Japan & S-Korea	BT, CE, FCC, ISED, Japan & S-Korea	BT, CE, FCC, ISED, Japan & S-Korea	
Other	Options with LNA available	Pin compatible with xGM111	World Smallest IoT Solution	No LF XTAL	No LF XTAL	

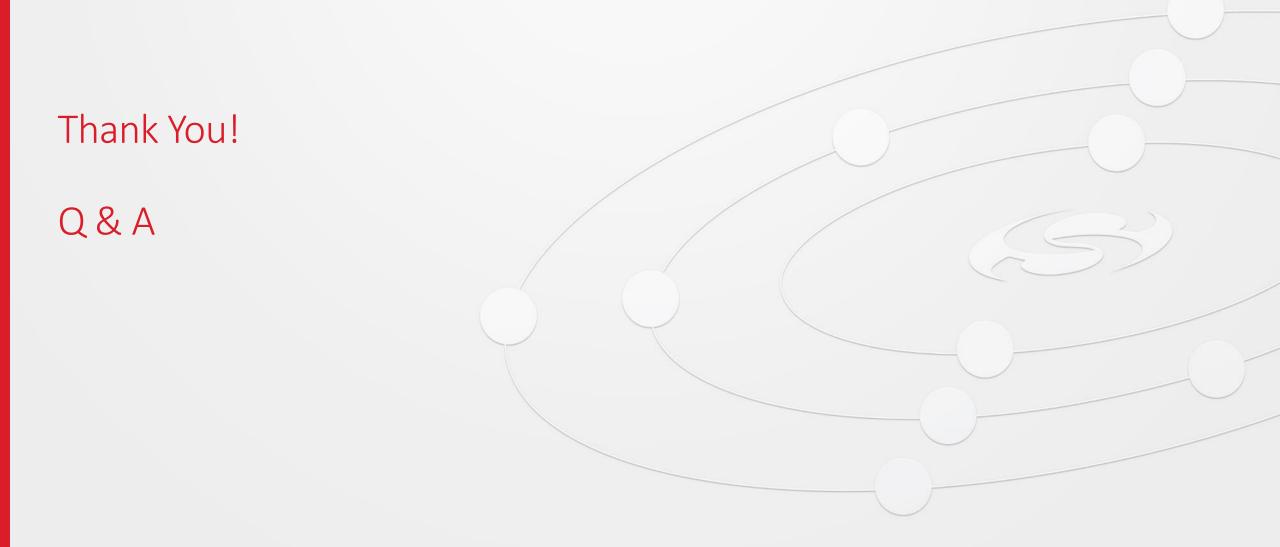




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SoC Selection Guidelines for Zigbee 3.x (R23) Specification 2020+

			512kB Flash	512kB Flash	768kB Flash	1MB Flash
Customer Use Case	Software Mode	OTA Image Storage	EFR32MG22	EFR32MG13/21	EFR32MG21	EFR32MG12/21
Gateways, Touchscreens, Door Locks w/ Host Processor	Single Protocol NCP Mode	External Flash	2			
Lights, Sensors, Door Locks, Actuators, Smart Outlets, Switch/Dimmers, Thermostats	Single Protocol End Devices and Routers Dynamic Multi-protocol w/ BLE SoC Mode	External Flash				
		Internal Flash	1	1		
		External Flash				
		Internal Flash				

EFR32MG1/14 and EM35xx devices are **Not recommended for new Zigbee designs targeting R23**

¹ Depending on the combination of protocol optional features, it **may require** external flash for OTA

² External PA is recommended

Flash estimations include: 50kB for Zigbee R23 code size growth, 16kB for bootloader, 15-36kB for CLI, 36kB for SimEEv2/NVM3, LZMA compression for OTA Consult Silicon Labs wireless support team or FAEs before making final architecture decisions.

SoC Selection Guidelines for OpenThread Ecosystems

			EFR32MG13	EFR32MG21	EFR32MG12
Customer Use Case	Software Mode	OTA Image Storage	512kB Flash	768kB/1MB Flash	1MB Flash
			64kB RAM	96kB RAM	256kB RAM
Gateways	Single Protocol RCP Mode	External Flash			
	Single Protocol NCP Mode	External Flash			
OpenWeave/CHIP Devices	Dynamic Multi-Protocol	External Flash	Future ²	1	
	w/ BLE SoC Mode	Internal Flash			Future ²

EFR32 MG12 is the recommended device today for SOCs due to the large Flash/RAM requirements of the application layers EM35xx devices are not supported

¹RAM constrained ²Future SoC support on 512kB parts is under review

Consult Silicon Labs wireless support team or FAEs before making final architecture decisions.